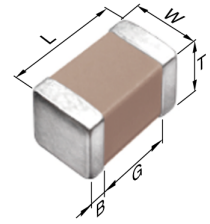


C3225JB0J686M200AC



TDK item description C3225JB0J686MT****

Applications	Commercial Grade
Feature	General General (Up to 50V)
Series	C3225 [EIA 1210]
Status	Production



Dimensions in mm

Size	
Length(L)	3.20mm ±0.40mm
Width(W)	2.50mm ±0.30mm
Thickness(T)	2.00mm ±0.20mm
Terminal Width(B)	0.20mm Min.
Terminal Spacing(G)	
Recommended Land Pattern (PA)	2.00mm to 2.40mm
Recommended Land Pattern (PB)	1.00mm to 1.20mm
Recommended Land Pattern (PC)	1.90mm to 2.50mm

Electrical Characteristics	
Capacitance	68μF ±20%
Rated Voltage	6.3VDC
Temperature Characteristic	jB(±10%)
Dissipation Factor (Max.)	15%
Insulation Resistance (Min.)	1MΩ

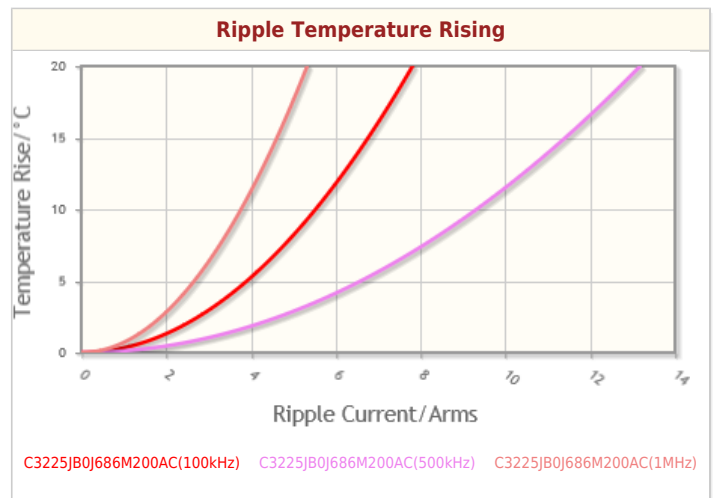
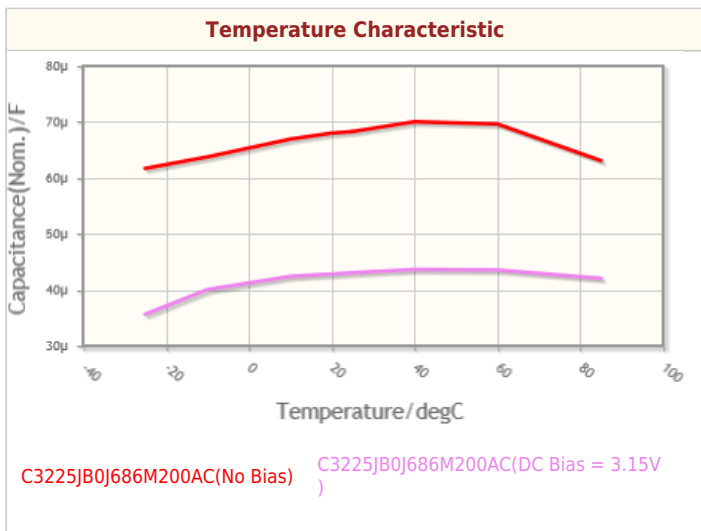
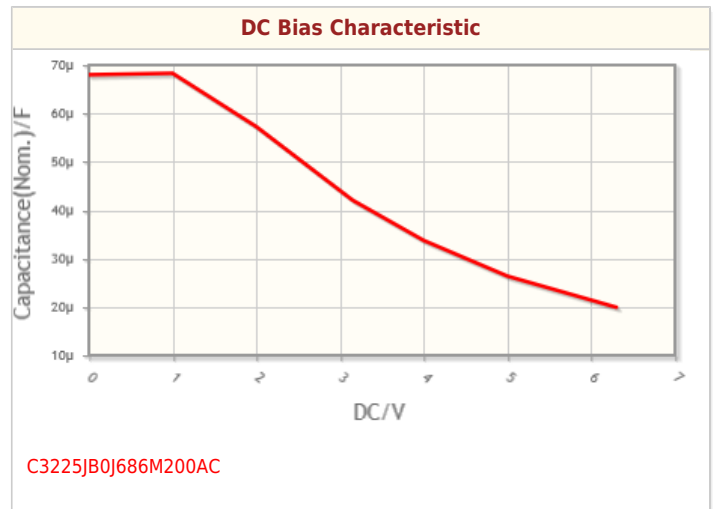
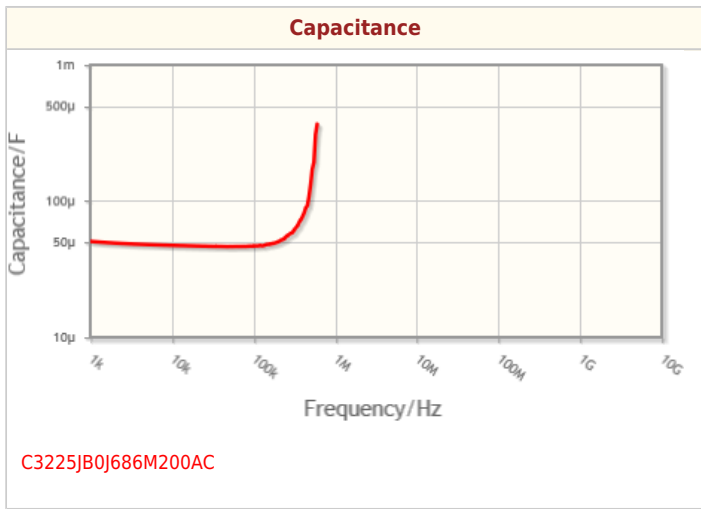
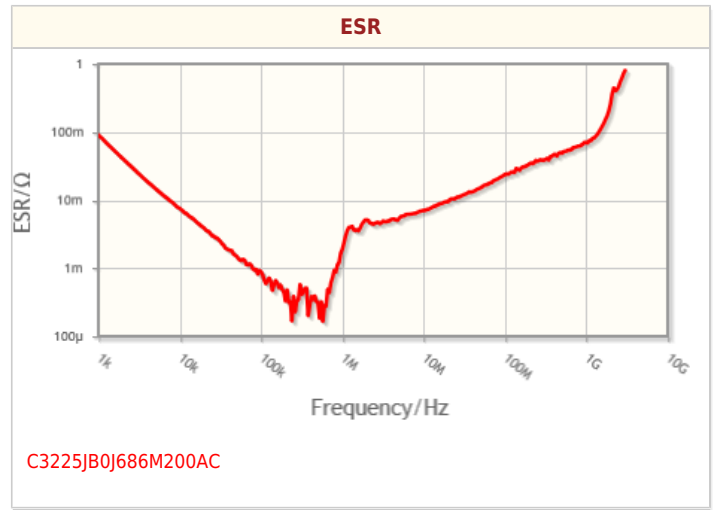
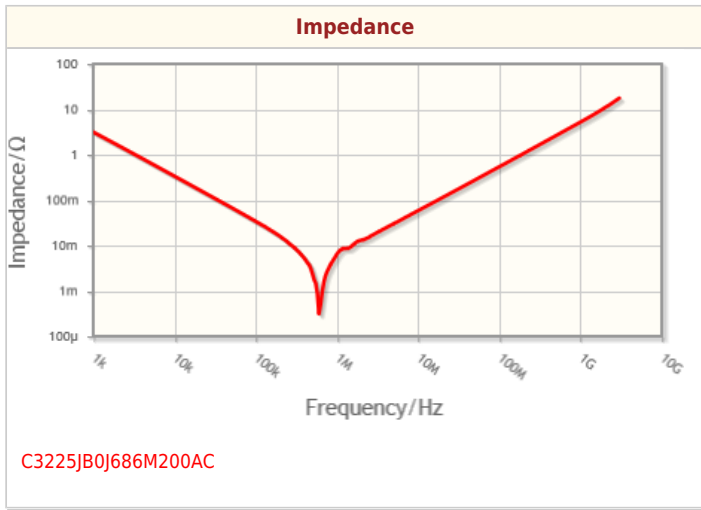
Other	
Soldering Method	Reflow
AEC-Q200	No
Packing	Blister (Plastic)Taping [180mm Reel]
Package Quantity	1000pcs

! Images are for reference only and show exemplary products.
! This PDF document was created based on the data listed on the TDK Corporation website.
! All specifications are subject to change without notice.

C3225JB0J686M200AC



Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

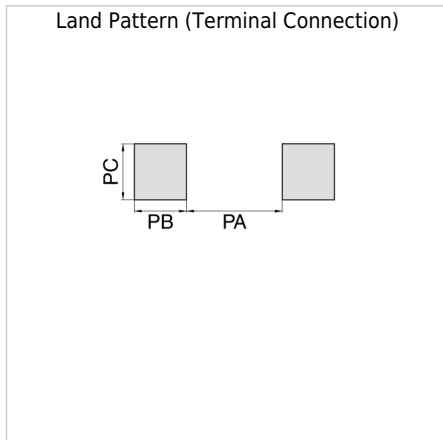


! Images are for reference only and show exemplary products.
! This PDF document was created based on the data listed on the TDK Corporation website.
! All specifications are subject to change without notice.

C3225JB0J686M200AC



Associated Images



! Images are for reference only and show exemplary products.
! This PDF document was created based on the data listed on the TDK Corporation website.
! All specifications are subject to change without notice.